



**Product data sheet** 

# 1. Product profile

### **1.1 General description**

Ultra-fast, epitaxial rectifier diode in a surface mount plastic package.

Product availability:

BYV29B-600 in SOT404 (D2PAK).

### 1.2 Features and benefits

- Low forward voltage
- Soft recovery characteristic

### **1.3 Applications**

Switched-mode power supplies

### **1.4 Quick reference data**

- V<sub>R</sub> ≤ 600 V
- I<sub>F(AV)</sub> ≤ 9 A

- Fast switching
   High thermal evolution
- High thermal cycling performance.
- Low loss rectification.
- V<sub>F</sub> ≤ 1.03 V
- $t_{rr} \le 60 \text{ ns}$

## 2. Pinning information

Table 1.	Pinning - SOT404 (D2PAK), simplified outline and symbol		
Pin	Description	Simplified outline	Symbol
1	no connection	mb	
2	cathode (k) [1]		K — A 001aaa020
3	anode (a)		
mb	mounting base; connected to cathode (k)		
		SOT404 (D2PAK)	

[1] It is not possible to make connection to pin 2 of the SOT404 package.

## 3. Ordering information

Table 2.     Ordering information						
Type number	Package					
	Name	Description	Version			
BYV29B-600	D2PAK	plastic single-ended surface mounted package; 3 leads (one lead cropped)	SOT404			

# 4. Limiting values

### Table 3. Limiting values

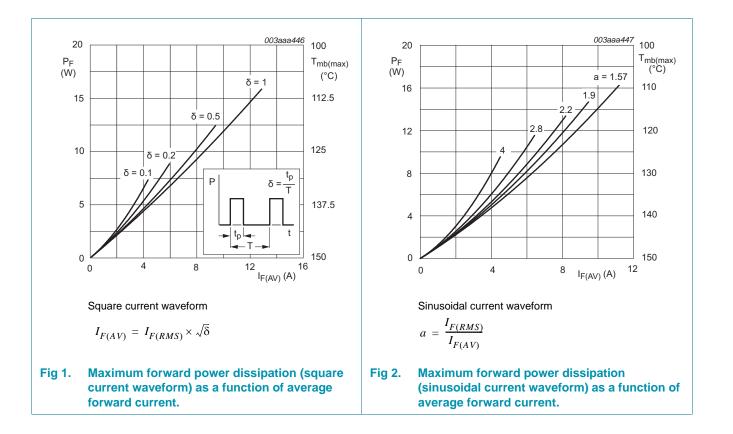
In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>RRM</sub>	repetitive peak reverse voltage		-	600	V
V <sub>RWM</sub>	crest working reverse voltage		-	600	V
V <sub>R</sub>	reverse voltage		-	600	V
I <sub>F(AV)</sub>	average forward current	square wave; $\delta$ = 0.5; $T_{mb} \leq$ 120 °C	<u>[1]</u> _	9	А
I <sub>FRM</sub>	repetitive peak forward current	square wave; t = 25 $\mu s;  \delta$ = 0.5; $T_{mb} \leq$ 120 °C	-	18	А
I <sub>FSM</sub>	non-repetitive peak forward current	sinusoidal; with reapplied $V_{\text{RRM}(\text{max})}$			
		t <sub>p</sub> = 10 ms	-	70	А
		t <sub>p</sub> = 8.3 ms	-	77	А
T <sub>stg</sub>	storage temperature		-40	+150	°C
Tj	junction temperature		-	+150	°C

[1] Neglecting switching and reverse current losses.

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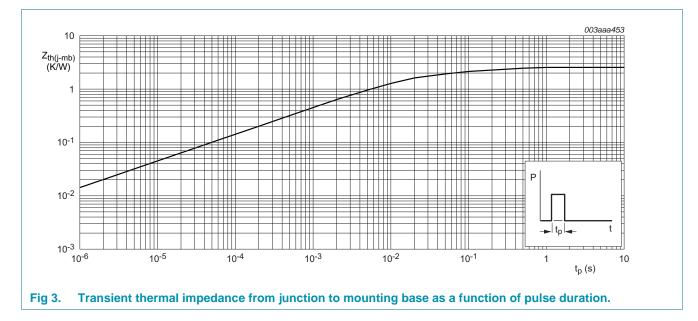


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## 5. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R <sub>th(j-mb)</sub>	thermal resistance from junction to mounting base	Figure 3	-	-	2.5	K/W
R <sub>th(j-a)</sub>	thermal resistance from junction to ambient	in free air	-	50	-	K/W

## 5.1 Transient thermal impedance



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# 6. Characteristics

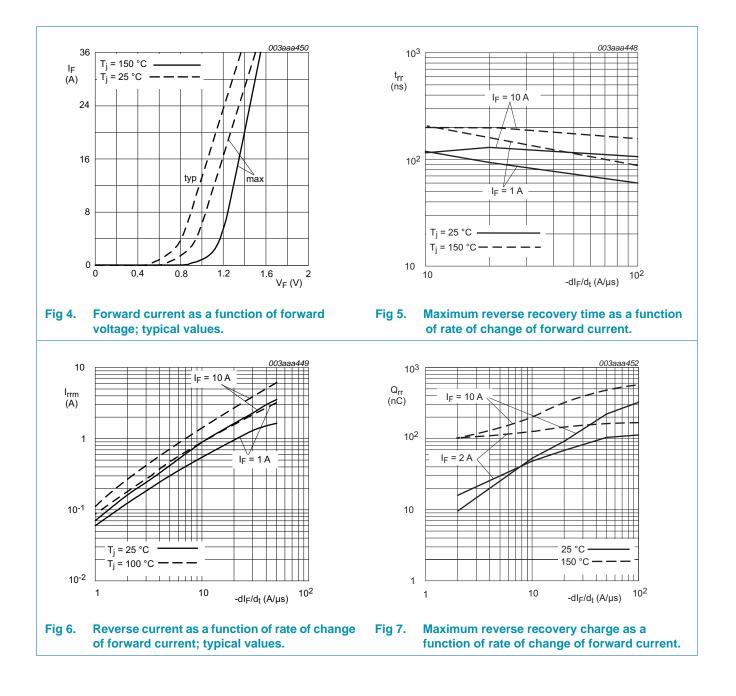
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static ch	aracteristics					
V <sub>F</sub>	forward voltage	I <sub>F</sub> = 8 A				
		T <sub>j</sub> = 150 °C; <u>Figure 4</u>	-	0.9	1.03	V
		T <sub>j</sub> = 25 °C; <u>Figure 4</u>	-	1.05	1.25	V
		I <sub>F</sub> = 20 A	-	1.3	1.45	V
I <sub>R</sub>	reverse current	$V_R = V_{RRM}$				
		T <sub>j</sub> = 100 °C	-	0.1	0.35	mA
		T <sub>j</sub> = 25 °C	-	2	50	μΑ
Dynamic	characteristics					
C <sub>d</sub>	diode capacitance	f = 1 MHz; V <sub>R</sub> = 100 V; <u>Figure 8</u>	-	7	-	pF
Q <sub>rr</sub>	reverse recovery charge	$I_{F}$ = 2 A; $V_{R}$ $\geq$ 30 V; $dI_{F}/dt$ = 20 A/µs; Figure 7	-	40	70	nC
t <sub>rr</sub>	reverse recovery time	$I_F$ = 1 A; $V_R \ge 30$ V; $dI_F/dt$ = 100 A/µs; Figure 5	-	50	60	ns
rrm	peak reverse recovery current	$ I_F = 10 \text{ A};  V_R \geq 30  \text{V};  \text{d}_F/\text{d}t = 50  \text{A}/\mu\text{s} \\ T_j = 100 ^\circ\text{C};  \underline{Figure \ 6} $	-	3	5.5	А
V <sub>fr</sub>	forward recovery voltage	$I_{F} = 10 \text{ A}; dI_{F}/dt = 10 \text{ A}/\mu \text{s}$	-	3.2	-	V

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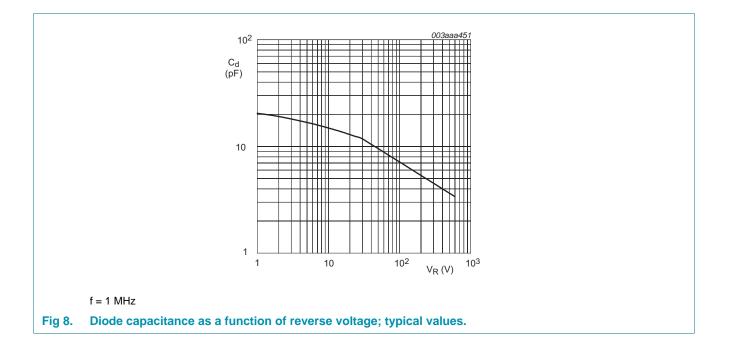
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# BYV29B-600

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**Rectifier diode ultrafast** 

# 7. Package outline

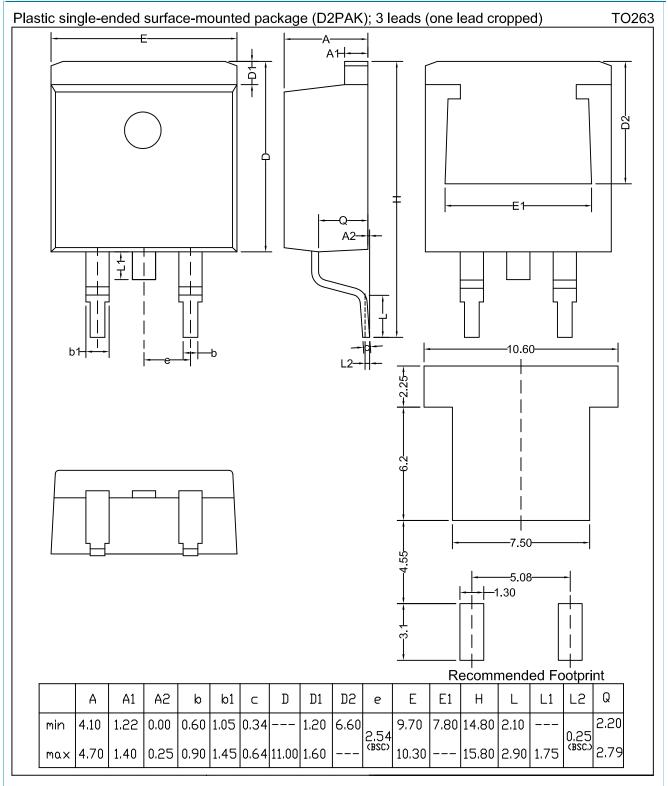


Fig 9. SOT404 (D2PAK).

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# 8. Revision history

Table 6. Revision h	nistory						
Document ID	Release date	Data sheet status	Change notice	Supersedes			
BYV29B_600 v.2	20110914	Product data sheet	-	BYV29B_600 v.1 (9397 750 11884)			
Modifications:		<ul> <li>The format of this data sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors.</li> </ul>					
	<ul> <li>Legal texts have been adapted to the new company name where appropriate.</li> </ul>						
	<ul> <li>Package outline drawings have been updated to the latest version.</li> </ul>						
BYV29B_600 v.1 (9397 750 11884)	20030811	Product data	-	-			

### **Ultrafast power diode**

## 9. Legal information

#### **Data sheet status**

Document status [1][2]	Product status [ <u>3]</u>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

- [2] The term 'short data sheet' is explained in section "Definitions".
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